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Part Number:

0738001000

Status:

Active

Overview:

[hdm](#)

Description:

2.00mm (.079") Pitch HDM® Board-to-Board Midplane Header, Vertical, SMC, Press-Fit, Long Pin, Open End Option, 144 Circuits

Documents:

[3D Model](#)

[Drawing \(PDF\)](#)

[Test Summary \(PDF\)](#)

[Product Specification PS-73780-999 \(PDF\)](#)

[RoHS Certificate of Compliance \(PDF\)](#)

Agency Certification

CSA

LR19980

UL

E29179

General

Product Family

Backplane Connectors

Series

73800

Application

Midplane

Component Type

PCB Header

Overview

[hdm](#)

Product Name

HDM®

Style

N/A

Physical

Circuits (Loaded)

144

Circuits (maximum)

144

Color - Resin

Black, Natural

Durability (mating cycles max)

250

First Mate / Last Break

No

Flammability

94V-0

Guide to Mating Part

No

Keying to Mating Part

None

Material - Plating Mating

Gold

Material - Plating Termination

Gold

Material - Resin

High Temperature Thermoplastic

Number of Columns

24

Number of Pairs

Open Pin Field

Number of Rows

6

Orientation

Vertical

PC Tail Length (in)

0.453 In

PC Tail Length (mm)

11.50 mm

PCB Locator

No

PCB Retention

Yes

PCB Thickness Recommended (in)

0.157 In

PCB Thickness Recommended (mm)

4.00 mm

Packaging Type

Tube

Pitch - Mating Interface (in)

0.079 In

Pitch - Mating Interface (mm)

2.00 mm

Pitch - Term. Interface (in)

0.079 In

Pitch - Term. Interface (mm)

2.00 mm

Plating min: Mating (µin)

30

Plating min: Mating (µm)

0.75

Plating min: Termination (µin)

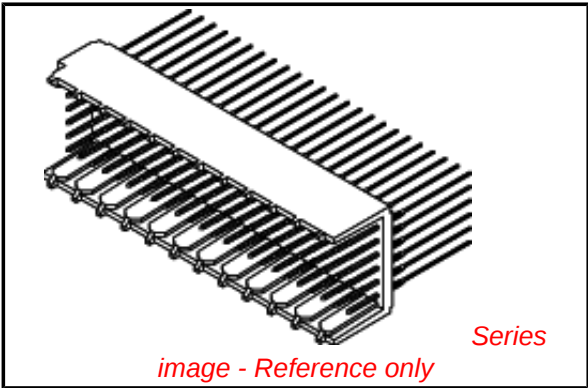
2

Plating min: Termination (µm)

0.05

Polarized to PCB

No



EU RoHS

ELV and RoHS

Compliant

REACH SVHC

Not Reviewed

Halogen-Free

Status

Not Reviewed

China RoHS



Need more information on product environmental compliance?

Email productcompliance@molex.com

For a multiple part number RoHS Certificate of Compliance, [click here](#)

Please visit the [Contact Us](#) section for any non-product compliance questions.

Search Parts in this Series

73800Series

Mates With

73632 HDM PLUS® Board-to-Board Daughtercard Receptacle. 73780 HDM® Board-to-Board Daughtercard Receptacle

Application Tooling | FAQ

Tooling specifications and manuals are found by selecting the products below. Crimp Height Specifications are then contained in the Application Tooling Specification document.

Global

Description	Product #
Flat Rock Tooling for	0622013700
Pneumatic Press	
HDM® Backplane	0622005703
Insertion Head for	
144 Positions	

Stackable	No
Surface Mount Compatible (SMC)	Yes
Temperature Range - Operating	-55°C to +105°C

Electrical

Current - Maximum per Contact	1A
Data Rate	1.0 Gbps
Real Signals (per 25mm)	75
Shielded	No
Voltage - Maximum	250V AC

Material Info

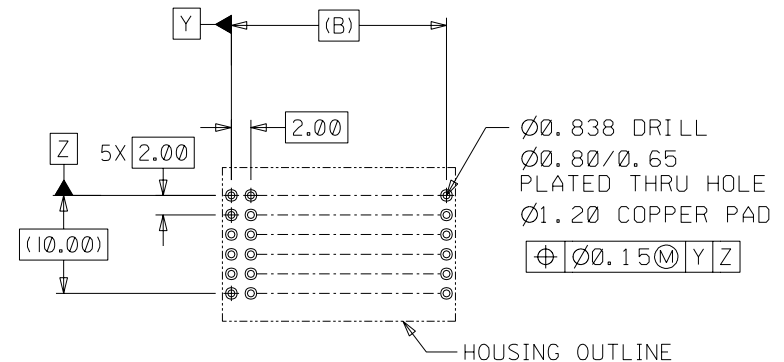
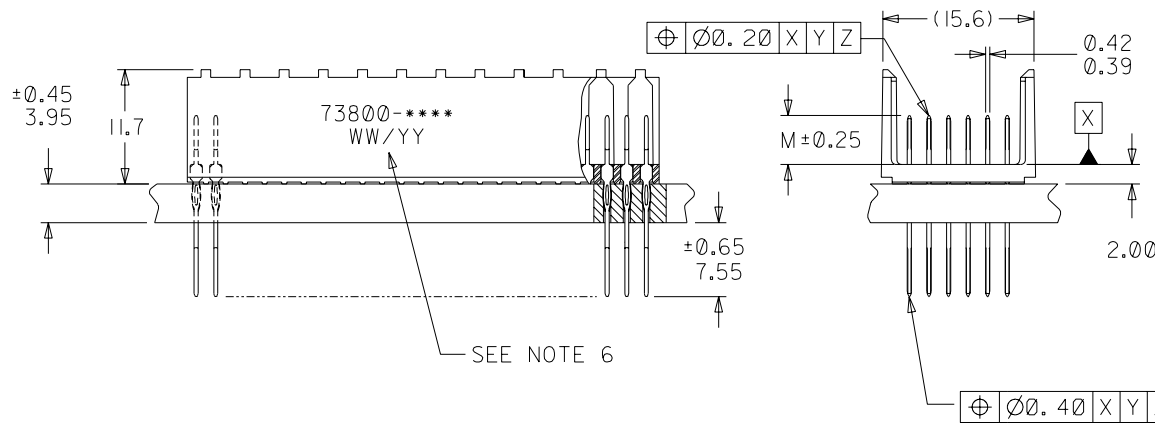
Reference - Drawing Numbers

Packaging Specification	PK-70873-0868
Product Specification	PS-73780-999
Sales Drawing	SD-73800-001

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This document was generated on 05/14/2010

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PCB LAYOUT: COMPONENT SIDE
RECOMMENDED PCB THICKNESS: 3.95±0.45

MATERIAL NUMBER	NUMBER OF CONTACTS	DIM "A"	DIM "B"	DIM "M"	PLATING
73800-0000	72	23.84	22.00	5.00	GOLD/GOLD FLASH
73800-0200	72	23.84	22.00	6.00	GOLD/GOLD FLASH
73800-1000	144	47.84	46.00	5.00	GOLD/GOLD FLASH
73800-1200	144	47.84	46.00	6.00	GOLD/GOLD FLASH
73800-2000	72	23.84	22.00	5.00	GOLD/TIN-LEAD
73800-2200	72	23.84	22.00	6.00	GOLD/TIN-LEAD
73800-3000	144	47.84	46.00	5.00	GOLD/TIN-LEAD
73800-3200	144	47.84	46.00	6.00	GOLD/TIN-LEAD

REVISED	EC NO. UCP2004-1438	QUALITY SYMBOLS
	DRWN: BINGHAM 04/02/04	MAJOR  = 0
	CHK: REED 04/02/04	CRITICAL  = 0
	APPR: BIXLER 04/02/04	
REV	DESCRIPTION	

GENERAL TOLERANCES: (UNLESS SPECIFIED)		
	mm	INCH
4 PLACES	± 0.1	$\pm .$
3 PLACES	± 0.1	$\pm .$
2 PLACES	± 0.05	$\pm .$
1 PLACE	± 0.10	$\pm .$
ANGULAR: $\pm 1/2^\circ$		
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		

SCALE 2 : 1	DESIGN UNITS ☒ mm ☐ INCH
DRAWN BY & DATE JBINGHAM 97/05/16	
CHECKED BY & DATE SREED 97/05/16	
APPROVED BY & DATE CBIXLER 97/05/16	
CAD FILENAME S73800X1.DGN	
THIS DRAWING CONTAINS INCORPORATED AND SHOWN	

 THIRD ANGLE PROJECTION	☐ mm INCH	☐ INCH mm	☒ mm ONLY	SIZE REVISE ON CAD ONLY
	TITLE: SALES ASSEMBLY HDM DOUBLE-END MIDPLANE OPEN END OPTION			
 MOLEX INCORPORATED				
MATERIAL NO. SEE CHART	DRAWING NO. SD-73800-001		SHEET NO. 1 OF 1	
ALL INFORMATION THAT IS PROPRIETARY TO MOLEX SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION.				SIZE B

Данный компонент на территории Российской Федерации

Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

Офис по работе с юридическими лицами:

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